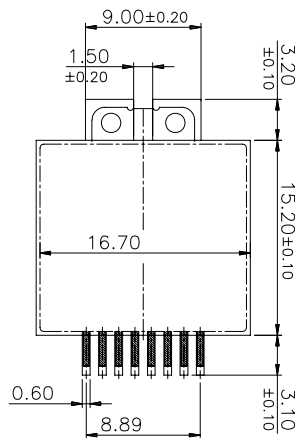
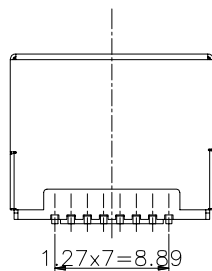
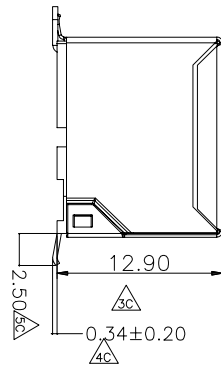
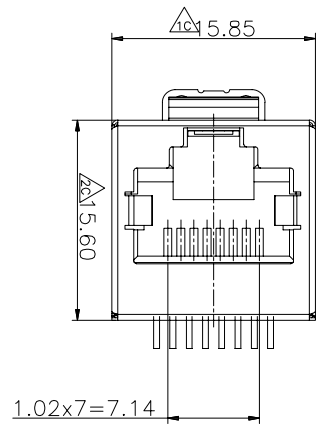


REV	ECN NO.	DATE



PC Board Layout

NOTES

- MATERIAL
 1. HOUSING MATERIAL
 2. CONTACT MATERIAL
 3. PLATING

: GLASS FILLED POLYESTER UL94V-0.
 : PHOSPHOR BRONZE T=0.35mm.
 : GOLD PLATING OVER NICKEL.
 : FU", 3U", 6U", 15U", 30", 50".
 : 0.20mm THICKNESS COPPER ALLOY WITH NICKEL PLATED.

4. SHIELD

ELECTRICAL

1. VOLTAGE RATING
 2. CURRENT RATING
 3. CONTACT RESISTANCE
 4. INSULATION RESISTANCE
 5. DIELECTRIC DIELECTRIC RESISTANCE

: 125 VAC RMS.
 : 1.5 AMP.
 : 30 MILLIOHMS MAX.
 : 500 MEGOHMS MIN @ 500V DC .
 : 1000V AC RMS 50Hz. 1MIN.

MECHANICAL

1. DURRABILITY
 2. PCB RETENTIONPRE-SOLDER

: 750 CYCLES MIN.
 : 1 LB MIN.

ENVIRONMENTAL:

1. STORAGE
 2. OPERATION

: -40°C~+85°C.
 : 0°C~+70°C.

RoHS Compliant

TOLERANCES 公差		DATE 日期	2013-09-26		© 库乐科技			
mm					TITEL 品名		RJ45 JACK	
.0± 0.30	±	MATERIAL 材质			PART NO. 料号		SIZE A4	
.00± 0.25	±	FINISH 电镀			10		Approved 核准	
.000± 0.10	±	SCALE 比例	1:1	UNIT 单位	mm	Checked 审核		SHEET 1 OF 1
ANGLES	± 1°	Designed 设计	张旺新					
THIRD ANGLE PROJECTION								